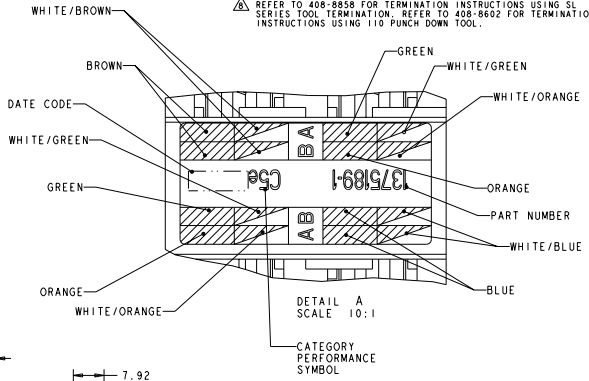
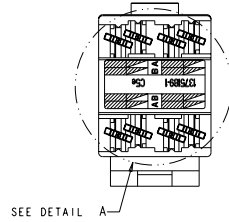
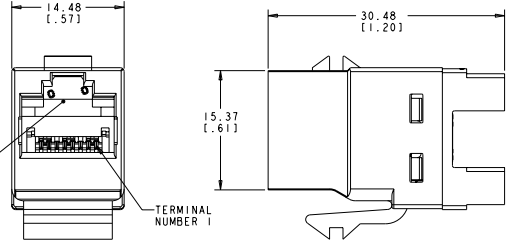
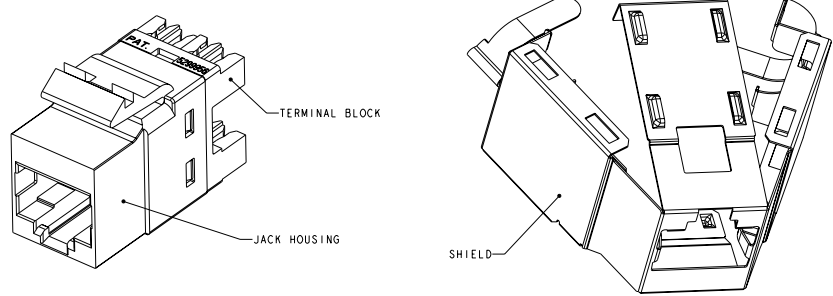


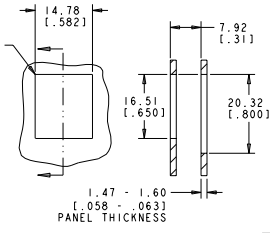
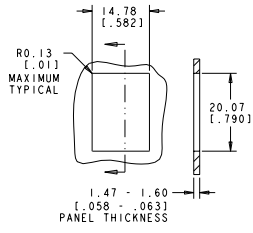
REV	DATE	DESCRIPTION	BY	CHK	APP
E	REV: ECO-06-02502		JANUARY	GG	BM
F	REV: ECO-07-015835		FEBRUARY	GG	SA
G	REV: ECO-08-02502		JANUARY	JB	SA

- ⚠ MATERIAL: JACK HOUSING - POLYPHENYLENE OXIDE, 94V-0 RATED, 110 BLOCK - POLYCARBONATE, ARRAY TRAY - PET POLYESTER, JACK CONTACTS ARRAY - BERYLLIUM COPPER, PLATED WITH 1.27µm (.00050) MINIMUM THICK GOLD IN LOCALIZED AREA AND 3.81µm (.00150) MINIMUM THICK MATTE TIN IN BOARD INTERFACE AREA OVER 1.27µm (.00050) MINIMUM THICK NICKEL UNDERPLATE, SHIELD - COPPER ZINC ALLOY 260 PREPLATED WITH BRIGHT NICKEL, IDC TERMINALS - PHOSPHOROUS BRONZE, PLATED WITH 3.81µm (.0015) MINIMUM THICK BRIGHT MATTE TIN OVER 1.27µm (.0005) MINIMUM THICK NICKEL UNDERPLATE, SHIELD - COPPER ZINC ALLOY 260 PREPLATED WITH BRIGHT NICKEL.
- 2. SL 110 JACK WILL TERMINATE 22-24 AWG SOLID AND 24-26 AWG STRANDED CONDUCTORS .271(.050) MAXIMUM INSULATION DIAMETER. JACK WILL ACCEPT CONDUCTORS UP TO 1.45 (.057) BUT REQUIRE THE USE OF A STRAIN RELIEF.
- ⚠ CAVITY CONFORMS TO FCC RULES AND REGULATIONS PART 68 SUBPART F REQUIREMENTS.
- 4. MOUNTING PANEL THICKNESS 1.47 - 1.60 (.058 - .063).
- ⚠ THESE TWO SUGGESTED CUTOFF OPENINGS ARE USED IN TANDEM WITH DUAL FRONT AND BACK CUTOUS.
- ⚠ ONE MODULAR JACK ASSEMBLY AND ONE SHIELD PER POLYBAG.
- 7. SHIELD SHIPPED NOT ASSEMBLED.
- ⚠ REFER TO 408-8858 FOR TERMINATION INSTRUCTIONS USING SL SERIES TOOL TERMINATION. REFER TO 408-8602 FOR TERMINATION INSTRUCTIONS USING 110 PUNCH DOWN TOOL.



COLOR CODE	IDC TERMINAL	MODULAR JACK
WHITE/BLUE	5	5
BLUE	4	4
WHITE/ORANGE	3	3
ORANGE	2	2
WHITE/GREEN	1	1
GREEN	6	6
WHITE/BROWN	7	7
BROWN	8	8

ELECTRICAL SCHEMATIC T568A



PACKAGE	HOUSING COLOR	PART NUMBER
BLACK		1375189-1

REV: 00	DATE: 05/01/01	BY: JMB	CHK: JMB	APP: JMB
DESCRIPTION: ASSEMBLY, SL 110 JACK, SHIELD, CATEGORY Se		SCALE: 10:1	CUSTOMER DRAWING	DATE: 05/01/01